



# **Glass Passivated Bridge Rectifiers**

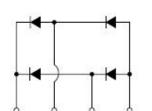
## **FEATURES**

- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326243
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition





**KBP** 





### **MECHANICAL DATA**

Case: KBP

Molding compound, UL flammability classification rating 94V-0 Base P/N with suffix "G" on packing code - halogen-free **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test **Polarity:** Polarity as marked on the body

Weight: 1.5 g (approximately)

		KBP	KBP	KBP	KBP	KBP	KBP	KBP	UNIT
PARAMETER	SYMBOL	201G	202G	203G	204G	205G	206G	207G	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	2						Α	
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>				60				Α
Rating for fusing (t<8.3ms)	l <sup>2</sup> t				15				A <sup>2</sup> s
Maximum instantaneous forward voltage (Note 1) $I_F$ = 2 A	V <sub>F</sub>	1.2					V		
	I <sub>R</sub>	10 500				μΑ			
Typical thermal resistance	$R_{ heta jL} \ R_{ heta jA}$	8 25					°C/W		
Operating junction temperature range	TJ	- 55 to +150					οС		
Storage temperature range	T <sub>STG</sub>			-	55 to +15	50			οС

Note 1: Pulse Test with PW=300µs,1% Duty Cycle



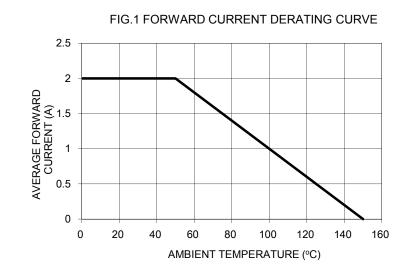
ORDERING INFORMATION							
PART NO.	PACKING CODE	GREEN COMPOUND	PACKAGE	PACKING			
		CODE					
KBP20xG (Note 1)	C2	Suffix "G"	KBP	25 / TUBE			

Note 1: "x" defines voltage from 50V (KBP201G) to 1000V (KBP207G)

EXAMPLE							
PREFERRED P/N PART NO		PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION			
KBP207G C2	KBP207G	C2					
KBP207G C2G	KBP207G	C2	G	Green compound			

### **RATINGS AND CHARACTERISTICS CURVES**

(TA=25°C unless otherwise noted)



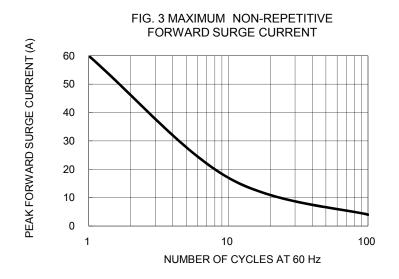


FIG. 2 TYPICAL REVERSE CHARACTERISTICS

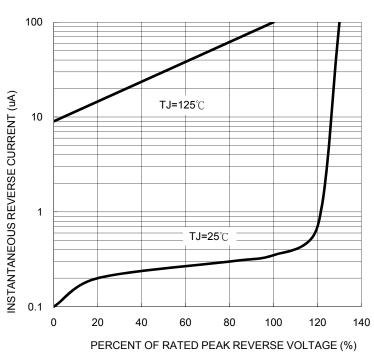
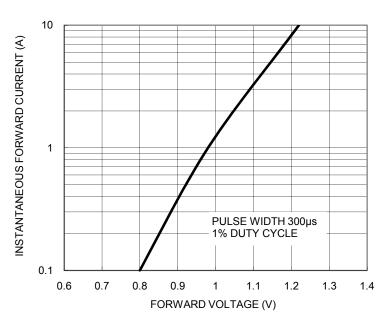
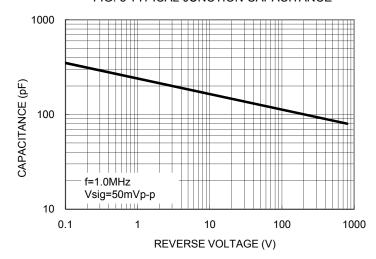


FIG. 4 TYPICAL FORWARD CHARACTERISTICS

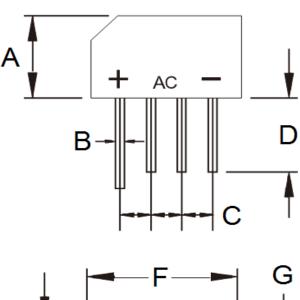


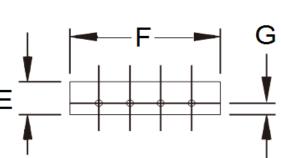


### FIG. 5 TYPICAL JUNCTION CAPACITANCE



## PACKAGE OUTLINE DIMENSIONS





DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Min Max		Max	
Α	10.60	11.68	0.417	0.460	
В	0.70	0.90	0.028	0.035	
С	3.60	4.10	0.142	0.161	
D	12.70	-	0.500	-	
Е	3.70	3.90	0.146	0.154	
F	14.22	15.24	0.560	0.600	
G	1.27	-	0.050	-	

## **MARKING DIAGRAM**



P/N = Specific Device Code

G = Green Compound

YW = Date Code

F = Factory Code



Taiwan Semiconductor

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<u>KBP201G KBP202G KBP203G KBP204G KBP204G KBP205G KBP206G KBP207G KBP201G C2 KBP206G C2</u>